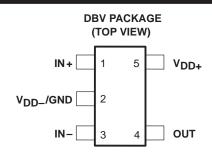
TLV2211, TLV2211Y Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

SLOS156B - MAY 1996 - REVISED JANUARY 1997

- Output Swing Includes Both Supply Rails
- Low Noise . . . 21 nV/ $\sqrt{\text{Hz}}$ Typ at f = 1 kHz
- Low Input Bias Current . . . 1 pA Typ
- Very Low Power . . . 13 μA Per Channel Typ
- Common-Mode Input Voltage Range Includes Negative Rail
- Wide Supply Voltage Range 2.7 V to 10 V
- Available in the SOT-23 Package
- Macromodel Included



description

The TLV2211 is a single operational amplifier manufactured using the Texas Instruments Advanced LinCMOSTM process. These devices are optimized and fully specified for single-supply 3-V and 5-V operation. For this low-voltage operation combined with micropower dissipation levels, the input noise voltage performance has been dramatically improved using optimized design techniques for CMOS-type amplifiers. Another added benefit is that these amplifiers exhibit rail-to-rail output swing. The output dynamic range can be extended using the TLV2211 with loads referenced midway between the rails. The common-mode input voltage range is wider than typical standard CMOS-type amplifiers. To take advantage of this improvement in performance and to make this device available for a wider range of applications, V_{ICR} is specified with a larger maximum input offset voltage test limit of \pm 5 mV, allowing a minimum of 0 to 2-V common-mode input voltage range for a 3-V power supply.

AVAILABLE OPTIONS

т.	V _{IO} max AT 25°C PACKAGED DEVICES		SYMBOL	CHIP FORM
TA	AlQuiax At 52.C	SOT-23 (DBV) [†]	STWIBUL	(Y)
0°C to 70°C	3 mV	TLV2211CDBV	VACC	TI V2211Y
-40°C to 85°C	3 mV	TLV2211IDBV	VACI	ILVZZIII

[†] The DBV package available in tape and reel only.

The Advanced LinCMOS process uses a silicon-gate technology to obtain input offset voltage stability with temperature and time that far exceeds that obtainable using metal-gate technology. This technology also makes possible input-impedance levels that meet or exceed levels offered by top-gate JFET and expensive dielectric-isolated devices.

The TLV2211, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources such as piezoelectric transducers. Because of the low power dissipation levels combined with 3-V operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single or split supplies makes these devices excellent choices when interfacing directly to analog-to-digital converters (ADCs). All of these features combined with its temperature performance make the TLV2211 ideal for remote pressure sensors, temperature control, active voltage-resistive (VR) sensors, accelerometers, hand-held metering, and many other applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Advanced LinCMOS is a trademark of Texas Instruments Incorporated.



TLV2211, TLV2211Y Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

SLOS156B - MAY 1996 - REVISED JANUARY 1997

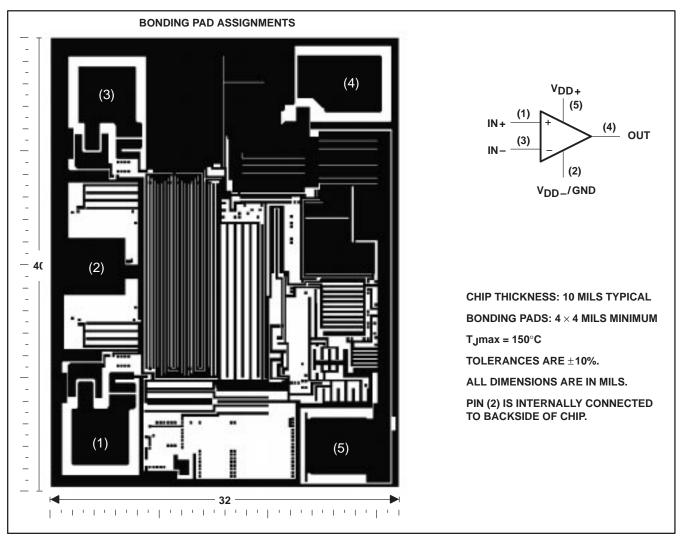
description (continued)

The device inputs and outputs are designed to withstand a 100-mA surge current without sustaining latch-up. In addition, internal ESD-protection circuits prevent functional failures up to 2000 V as tested under MIL-PRF-38535; however, care should be exercised when handling these devices as exposure to ESD may result in degradation of the device parametric performance. Additional care should be exercised to prevent V_{DD+} supply-line transients under powered conditions. Transients of greater than 20 V can trigger the ESD-protection structure, inducing a low-impedance path to V_{DD-}/GND . Should this condition occur, the sustained current supplied to the device must be limited to 100 mA or less. Failure to do so could result in a latched condition and device failure.



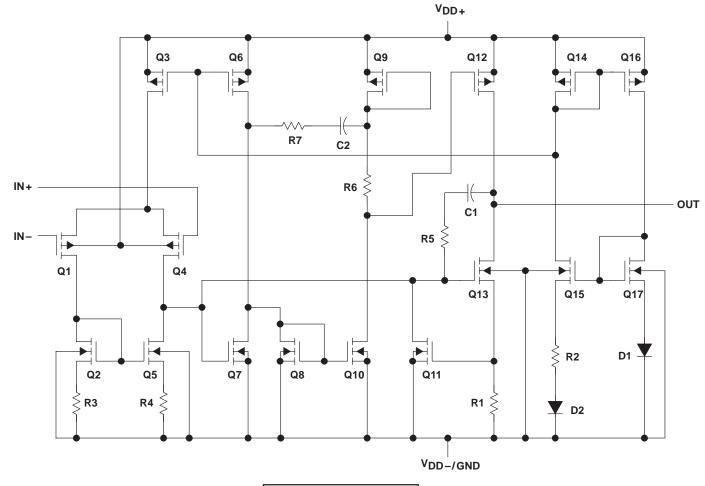
TLV2211Y chip information

This chip, when properly assembled, displays characteristics similar to the TLV2211C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. This chip may be mounted with conductive epoxy or a gold-silicon preform.



lemplate Release

equivalent schematic



COMPONENT COUNT [†]						
Transistors	23					
Diodes	6					
Resistors	11					
Capacitors	2					

[†] Includes both amplifiers and all ESD, bias, and trim circuitry

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{DD} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	±V _{DD}
Input voltage range, V _I (any input, see Note 1)	0.3 V to V _{DD}
Input current, I _I (each input)	±5 mA
Output current, IO	±50 mA
Total current into V _{DD+}	±50 mA
Total current out of V _{DD}	±50 mA
Duration of short-circuit current (at or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A : TLV2211C	0°C to 70°C
TLV2211I	–40°C to 85°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DBV	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to VDD -.
 - 2. Differential voltages are at the noninverting input with respect to the inverting input. Excessive current flows when input is brought below V_{DD} = 0.3 V.
 - 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ Power rating	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
DBV	150 mW	1.2 mW/°C	96 mW	78 mW

recommended operating conditions

	TLV2211C		TL	UNIT	
	MIN	MAX	MIN	MAX	UNIT
Supply voltage, V _{DD} (see Note 1)	2.7	10	2.7	10	V
Input voltage range, V _I	V_{DD-}	V _{DD+} -1.3	V_{DD-}	V _{DD+} -1.3	V
Common-mode input voltage, V _{IC}	V _{DD} _	V _{DD+} -1.3	V _{DD} -	V _{DD+} -1.3	V
Operating free-air temperature, TA	0	70	-40	85	°C

NOTE 1: All voltage values, except differential voltages, are with respect to VDD -.



TLV2211, TLV2211Y Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

SLOS156B - MAY 1996 - REVISED JANUARY 1997

electrical characteristics at specified free-air temperature, $V_{DD} = 3 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST COND	TEST CONDITIONS TAT		TI	V22110	С	Т	LV2211	I	UNIT
	FARAWIETER	TEST COND	IIIONS	'A'	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
VIO	Input offset voltage					0.47	3		0.47	3000	mV
αVIO	Temperature coefficient of input offset voltage	.457	V 0	Full range		1			1		μV/°C
	Input offset voltage long-term drift (see Note 4)	$V_{DD\pm} = \pm 1.5 \text{ V},$ $V_{O} = 0,$	$V_{IC} = 0$, RS = 50 Ω	25°C		0.003			0.003		μV/mo
lιΟ	Input offset current			Full range		0.5	150		0.5	150	pА
I_{IB}	Input bias current			Full range		1	150		1	150	pА
VICR	Common-mode input voltage range	V _{1O} ≤5 mV,	$O \mid \leq 5 \text{ mV},$ $R_S = 50 \Omega$	25°C	0 to 2	-0.3 to 2.2		0 to 2	-0.3 to 2.2		V
voltage range			Full range	to 1.7			to 1.7				
	LP also be collected	$I_{OH} = -100 \mu A$		25°C		2.94			2.94		
∨он	High-level output voltage	I _{OH} = -250 μA		25°C		2.85			2.85		V
		ΙΟΗ = -230 μΑ		Full range	2.5			2.5			
	Less less less textes d	V _{IC} = 1.5 V,	$I_{OL} = 50 \mu A$	25°C		15			15		
VOL	Low-level output voltage		I _{OL} = 500 μA	25°C		150			150		mV
		VIC = 1.5 V,		Full range			500			500	
	Large-signal	V _{IC} = 1.5 V,	$R_{I} = 10 \text{ k}\Omega^{\ddagger}$	25°C	3	7		3	7		
AVD	differential voltage	$V_{O} = 1.5 \text{ V},$ $V_{O} = 1 \text{ V to 2 V}$	_	Full range	1			1			V/mV
	amplification		$R_L = 1 M\Omega^{\ddagger}$	25°C		600			600		
ri(d)	Differential input resistance			25°C		1012			1012		Ω
r _{i(c)}	Common-mode input resistance			25°C		1012			1012		Ω
Ci(c)	Common-mode input capacitance	f = 10 kHz,		25°C		5			5		pF
z _O	Closed-loop output impedance	f = 7 kHz,	A _V = 1	25°C		200			200		Ω
CMRR	Common-mode	$V_{IC} = 0 \text{ to } 1.7 \text{ V},$	V _O = 1.5 V,	25°C	65	83		65	83		dB
CIVIKK	rejection ratio	$R_S = 50 \Omega$		Full range	60			60			uв
ksvr	Supply voltage rejection ratio	V _{DD} = 2.7 V to 8 V,	$V_{IC} = V_{DD}/2$	25°C	80	95		80	95		dB
	$(\Delta V_{DD} / \Delta V_{IO})$	INU IUAU	,	Full range	80			80			
IDD	Supply current	V _O = 1.5 V, No load	25°C		11	25		11	25	μА	
-טט		- 1.0 v,	. 10 1044	Full range			30			30	μΑ

 $[\]frac{\dagger}{\tau}$ Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is – 40°C to 85°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150$ °C extrapolated to $T_A = 25$ °C using the Arrhenius equation and assuming an activation energy of 0.96 eV.



[‡]Referenced to 1.5 V

operating characteristics at specified free-air temperature, $V_{DD} = 3 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST COND	ITIONE	- +	Т	LV2211	С	1	TLV2211	I	UNIT	
	PARAMETER	TEST COND	IIIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNII	
		V- 44V+-40V	D. 40 lect	25°C	0.01	0.025		0.01	0.025			
SR	Slew rate at unity gain	$V_O = 1.1 \text{ V to } 1.9 \text{ V},$ $C_L = 100 \text{ pF}^{\ddagger}$	RL = 10 K22+,	Full range	0.005			0.005			V/μs	
\ <u></u>	Equivalent input noise	f = 10 Hz		25°C		80			80		2)//s/II=	
V _n	voltage	f = 1 kHz	1 kHz			22			22		nV/√Hz	
V	Peak-to-peak equivalent	f = 0.1 Hz to 1 Hz		25°C		660			660		μ٧	
V _{N(PP)}	input noise voltage	f = 0.1 Hz to 10 Hz		25°C		880			880		μν	
In	Equivalent input noise current			25°C		0.6			0.6		fA/√Hz	
	Gain-bandwidth product	f = 10 kHz, C _L = 100 pF‡	$R_L = 10 \text{ k}\Omega^{\ddagger}$,	25°C		56			56		kHz	
ВОМ	Maximum output-swing bandwidth	$V_{O(PP)} = 1 \text{ V},$ $R_{L} = 10 \text{ k}\Omega^{\ddagger},$	$A_V = 1,$ $C_L = 100 \text{ pF}^{\ddagger}$	25°C		7			7		kHz	
φm	Phase margin at unity gain	$R_L = 10 \text{ k}\Omega^{\ddagger}$,	C _L = 100 pF‡	25°C		56°			56°	·		
	Gain margin			25°C		20			20		dB	

[†] Full range is -40°C to 85°C.

[‡]Referenced to 1.5 V

TLV2211, TLV2211Y Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

SLOS156B - MAY 1996 - REVISED JANUARY 1997

electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS TAT		T	LV22110	С	Т	LV2211	I		
	PARAMETER	TEST COND	IIIONS	'A'	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
۷ıO	Input offset voltage					0.45	3		0.45	3	mV
αVIO	Temperature coefficient of input offset voltage			Full range		0.5			0.5		μV/°C
	Input offset voltage long-term drift (see Note 4)	$V_{DD\pm} = \pm 2.5 \text{ V},$ $V_{O} = 0,$	$V_{IC} = 0$, $R_S = 50 \Omega$	25°C		0.003			0.003		μV/mo
IIO	Input offset current			25°C		0.5			0.5		pА
.10	mpat onoot carront			Full range			150			150	Ρ, .
Iв	Input bias current			25°C		1			1		pА
110				Full range			150			150	P* ·
Common-mode input	V _O ≤5 mV	Rs = 50 Ω	25°C	0 to 4	-0.3 to 4.2		0 to 4	-0.3 to 4.2		V	
VICR	voltage range	gerange	KS = 50 12	Full range	0 to 3.5			0 to 3.5			V
		I _{OH} = -100 μA		25°C		4.95			4.95		
∨он	VOH voltage	J 050 A		25°C		4.875			4.875		V
1	voltage	I _{OH} = -250 μA		Full range	4.5			4.5			
		V _{IC} = 2.5 V,	I _{OL} = 50 μA	25°C		12			12		
V_{OL}	Low-level output voltage	V _{IC} = 2.5 V,	lo 500 uA	25°C		120			120		mV
		VIC = 2.5 V,	$I_{OL} = 500 \mu\text{A}$	Full range			500			500	
	Large-signal	.,	R _L = 10 kΩ [‡]	25°C	6	12		6	12		V/mV
AVD	differential	$V_{IC} = 2.5 \text{ V},$ $V_{O} = 1 \text{ V to 4 V}$		Full range	3			3			
	voltage amplification	10-100-0	$R_L = 1 M\Omega^{\ddagger}$	25°C		800			800		
r _{i(d)}	Differential input resistance			25°C		10 ¹²			10 ¹²		Ω
ri(c)	Common-mode input resistance			25°C		1012			1012		Ω
^C i(c)	Common-mode input capacitance	f = 10 kHz,		25°C		5			5		pF
z _O	Closed-loop output impedance	f = 7 kHz,	A _V = 1	25°C		200			200		Ω
CMRR	Common-mode	$V_{IC} = 0 \text{ to } 2.7 \text{ V},$	V _O = 2.5 V,	25°C	70	83		70	83		dB
Civilaia	rejection ratio	$R_S = 50 \Omega$		Full range	70			70			uD
ksvr	Supply voltage rejection ratio	$V_{DD} = 4.4 \text{ V to 8 V},$ No load	$V_{IC} = V_{DD}/2$,	25°C	80	95		80	95		dB
	(ΔV _{DD} /ΔV _{IO})		F	Full range	80			80			
IDD	Supply current	V _O = 2.5 V,	No load	25°C		13	25		13	25	μΑ
		0°C to 70°C Full rongs		Full range			30			30	·

[†] Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is -40°C to 85°C.



[‡]Referenced to 1.5 V

NOTE 5: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150$ °C extrapolated to $T_A = 25$ °C using the Arrhenius equation and assuming an activation energy of 0.96 eV.

operating characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		- +	Т	LV2211	С	1	LV2211	I	UNIT
	PARAMETER	TEST COND	ITIONS	T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNII
		V 45V1505V B		25°C	0.01	0.025		0.01	0.025		
SR	Slew rate at unity gain	$C_L = 100 \text{ pF}^{\ddagger}$	-		0.005			0.005			V/μs
V	Equivalent input noise	f = 10 Hz		25°C		72			72		nV/√ Hz
V _n	voltage	f = 1 kHz		25°C		21			21		IIV/∀⊓Z
V	Peak-to-peak equivalent	f = 0.1 Hz to 1 Hz f = 0.1 Hz to 10 Hz		25°C		600			600		μV
V _N (PP)	input noise voltage			25°C		800			800		μν
In	Equivalent input noise current			25°C		0.6			0.6		fA/√ Hz
	Gain-bandwidth product	f = 10 kHz, $C_L = 100 \text{ pF}^{\ddagger}$	$R_L = 10 \text{ k}\Omega^{\ddagger}$,	25°C		65			65		kHz
ВОМ	Maximum output-swing bandwidth	$V_{O(PP)} = 2 \text{ V},$ $R_L = 10 \text{ k}\Omega^{\ddagger},$	$A_V = 1,$ $C_L = 100 \text{ pF}^{\ddagger}$	25°C		7			7		kHz
фm	Phase margin at unity gain	R _L = 10 kΩ [‡] ,	C _L = 100 pF‡	25°C		56°	·		56°		
	Gain margin			25°C		22			22		dB

[†]Full range is -40°C to 85°C.

electrical characteristics at V_{DD} = 3 V, T_{A} = 25°C (unless otherwise noted)

	DADAMETED	TEG	T CONDITIONS		TI	V2211Y	′	
	PARAMETER	163	ST CONDITIONS		MIN	TYP	MAX	UNIT
Vio	Input offset voltage					0.47		mV
lιο	Input offset current	$V_{DD\pm} = \pm 1.5 \text{ V},$ $R_S = 50 \Omega$	$V_O = 0$,	$V_{IC} = 0,$		0.5		рА
I _{IB}	Input bias current	10 22				1		pА
VICR	Common-mode input voltage range	V _{IO} ≤5 mV,	R _S = 50 Ω			-0.3 to 2.2		V
V	High level output voltage	I _{OH} = -100 μA				2.94		V
VOH	High-level output voltage	$I_{OH} = -200 \mu\text{A}$ 2.85					V	
V	Low lovel output voltage	V _{IC} = 0,	I _{OL} = 50 μA			15		mV
VOL	Low-level output voltage	V _{IC} = 0,	I _{OL} = 500 μA			150		IIIV
Δ	Large-signal differential	V 4.5.V		$R_L = 10 \text{ k}\Omega^{\dagger}$		7		V/mV
AVD	voltage amplification	$V_{IC} = 1.5 V,$	$V_O = 1 V to 2 V$	$R_L = 1 M\Omega^{\dagger}$	1 ΜΩ†			V/IIIV
ri(d)	Differential input resistance			•		1012		Ω
r _{i(c)}	Common-mode input resistance					1012		Ω
^C i(c)	Common-mode input capacitance	f = 10 kHz				5		pF
z _o	Closed-loop output impedance	f = 7 kHz,	A _V = 1			200		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = 0 \text{ to } 1.7 \text{ V},$	V _O = 1.5 V,	R _S = 50 Ω		83		dB
ksvr	Supply voltage rejection ratio (ΔV _{DD} /ΔV _{IO})	V _{DD} = 2.7 V to 8 V,	$V_{IC} = V_{DD}/2,$	No load		95		dB
I _{DD}	Supply current	V _O = 1.5 V,	No load	·		11	·	μΑ

[†] Referenced to 1.5 V



[‡]Referenced to 1.5 V

TLV2211, TLV2211Y Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS SLOS156B - MAY 1996 - REVISED JANUARY 1997

electrical characteristics at V_{DD} = 5 V, T_{A} = 25°C (unless otherwise noted)

PARAMETER		TEG	ST CONDITIONS		TI	LV2211\	′	LINUT
	PARAMETER	l es	ST CONDITIONS		MIN	TYP	MAX	UNIT
VIO	Input offset voltage					0.45		mV
IIO	Input offset current	$V_{DD} \pm = \pm 2.5 \text{ V},$ $R_S = 50 \Omega$	$V_{IC} = 0$,	$V_{O} = 0$,		0.5		pА
I _{IB}	Input bias current	113 = 30 22				1		pА
VICR	Common-mode input voltage range	V _{IO} ≤5 mV,	R _S = 50 Ω			-0.3 to 4.2		V
V	High lovel output voltage	I _{OH} = -100 μA				4.95		V
VOH	High-level output voltage	Ι _{ΟΗ} = -250 μΑ			4.875		V	
Vai	Low-level output voltage	V _{IC} = 2.5 V,	I _{OL} = 50 μA			12		mV
VOL	Low-level output voltage	V _{IC} = 2.5 V,	I _{OL} = 500 μA			120		IIIV
Λ	Large-signal differential	V 2 5 V		$R_L = 10 \text{ k}\Omega^{\dagger}$		12		V/mV
AVD	voltage amplification	V _{IC} = 2.5 V,	$V_O = 1 V \text{ to } 4 V$	$R_L = 1 M\Omega^{\dagger}$	800			V/IIIV
r _{i(d)}	Differential input resistance					1012		Ω
r _{i(c)}	Common-mode input resistance					1012		Ω
c _{i(c)}	Common-mode input capacitance	f = 10 kHz				5		pF
z _O	Closed-loop output impedance	f = 7 kHz,	A _V = 1			200		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = 0 \text{ to } 2.7 \text{ V},$	V _O = 2.5 V,	$R_S = 50 \Omega$		83		dB
ksvr	Supply voltage rejection ratio $(\Delta V_{DD}/\Delta V_{IO})$	$V_{DD} = 4.4 \text{ V to 8 V},$	$V_{IC} = V_{DD}/2,$	No load		95		dB
I_{DD}	Supply current	$V_0 = 2.5 V$,	No load			13		μΑ

[†] Referenced to 1.5 V



Table of Graphs

			FIGURE
VIO	Input offset voltage	Distribution vs Common-mode input voltage	1, 2 3, 4
αVIO	Input offset voltage temperature coefficient	Distribution	5, 6
I _{IB} /I _{IO}	Input bias and input offset currents	vs Free-air temperature	7
VI	Input voltage	vs Supply voltage vs Free-air temperature	8 9
Vон	High-level output voltage	vs High-level output current	10, 13
V _{OL}	Low-level output voltage	vs Low-level output current	11, 12, 14
VO(PP)	Maximum peak-to-peak output voltage	vs Frequency	15
los	Short-circuit output current	vs Supply voltage vs Free-air temperature	16 17
٧o	Output voltage	vs Differential input voltage	18, 19
A _{VD}	Differential voltage amplification	vs Load resistance vs Frequency vs Free-air temperature	20 21, 22 23, 24
z _O	Output impedance	vs Frequency	25, 26
CMRR	Common-mode rejection ratio	vs Frequency vs Free-air temperature	27 28
k _{SVR}	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature	29, 30 31
l _{DD}	Supply current	vs Supply voltage	32
SR	Slew rate	vs Load capacitance vs Free-air temperature	33 34
٧o	Large-signal pulse response	vs Time	35, 36, 37, 38
VO	Small-signal pulse response	vs Time	39, 40, 41, 42
V _n	Equivalent input noise voltage	vs Frequency	43, 44
	Noise voltage (referred to input)	Over a 10-second period	45
THD + N	Total harmonic distortion plus noise	vs Frequency	46
	Gain-bandwidth product	vs Free-air temperature vs Supply voltage	47 48
фm	Phase margin	vs Frequency vs Load capacitance	21, 22 49
	Gain margin	vs Load capacitance	50
B ₁	Unity-gain bandwidth	vs Load capacitance	51

30

10

5

-1.5

Precentage of Amplifiers - %

TYPICAL CHARACTERISTICS

1.5

DISTRIBUTION OF TLV2211 INPUT OFFSET VOLTAGE 376 Amplifiers From 1 Wafer Lot $V_{DD} = \pm 1.5 \text{ V}$ $T_A = 25^{\circ}C$ 25 20 15

Figure 1

VIO - Input Offset Voltage - mV

0.5

-0.5

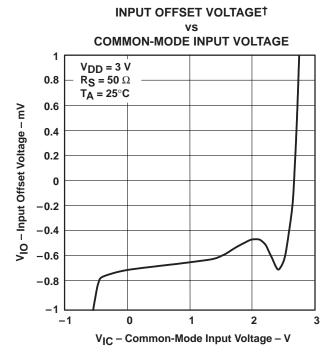


Figure 3

DISTRIBUTION OF TLV2211 INPUT OFFSET VOLTAGE

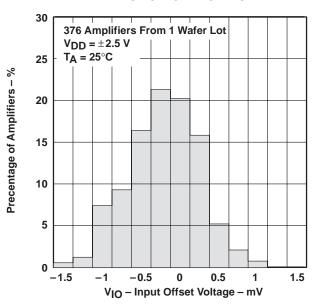


Figure 2

INPUT OFFSET VOLTAGE[†] VS **COMMON-MODE INPUT VOLTAGE**

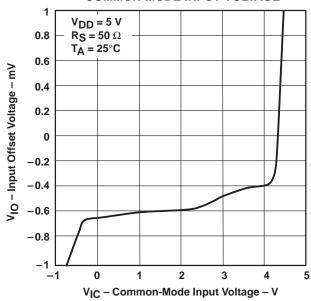


Figure 4

† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.



TYPICAL CHARACTERISTICS

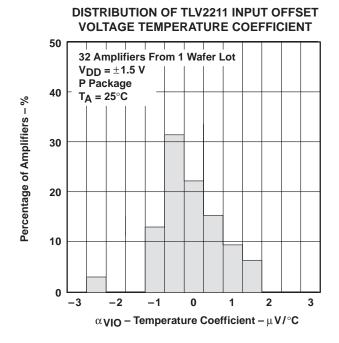
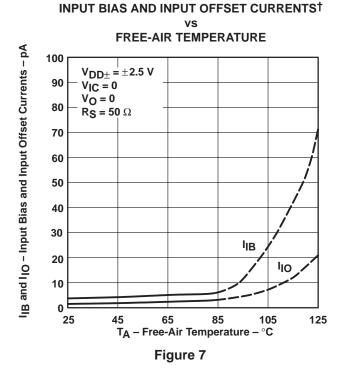


Figure 5



DISTRIBUTION OF TLV2211 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

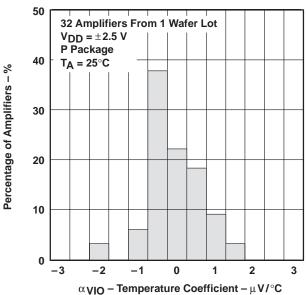
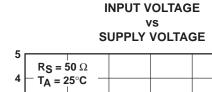


Figure 6



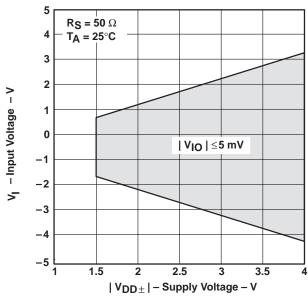


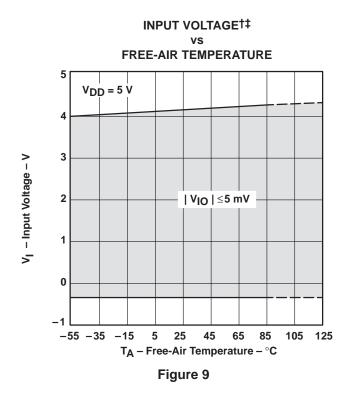
Figure 8

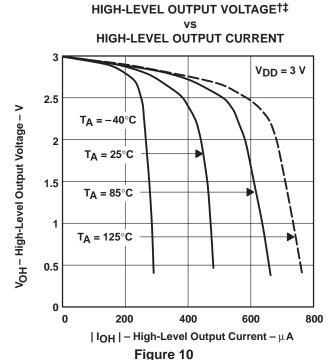


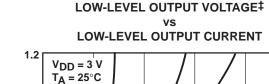
STRUMENTS

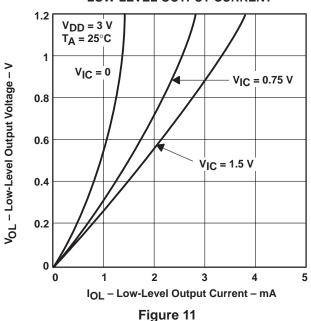
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

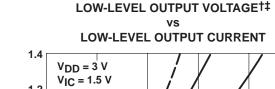
† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

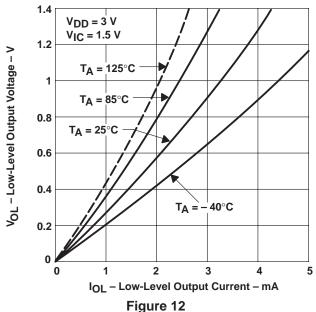








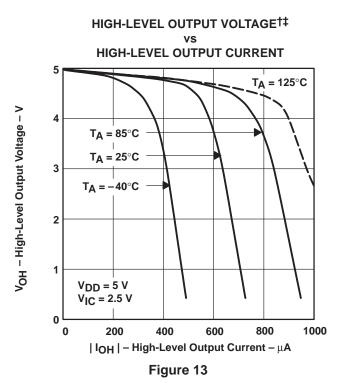




[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

[‡] For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.





LOW-LEVEL OUTPUT VOLTAGE†‡ **LOW-LEVEL OUTPUT CURRENT** 1.4 $V_{DD} = 5 V$ V_{IC} = 2.5 V 1.2 VOL - Low-Level Output Voltage - V T_A = 125°C T_A = 85°C 0.8 $T_A = 25^{\circ}C$ 0.6 0.4 -40°C 0.2 0 2 3 4 5 6 IOL - Low-Level Output Current - mA

MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE‡ vs

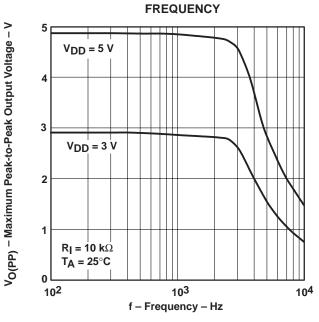


Figure 15

SHORT-CIRCUIT OUTPUT CURRENT vs
SUPPLY VOLTAGE

Figure 14

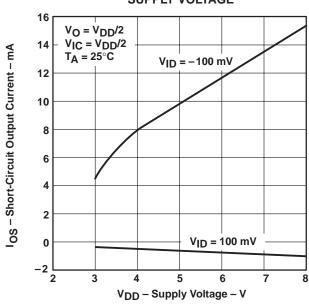


Figure 16

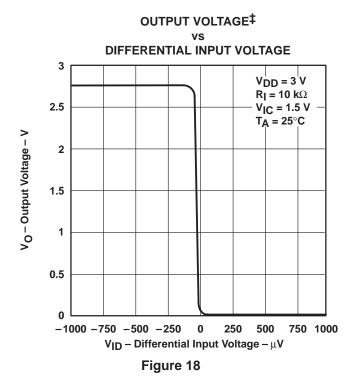
[‡] For all curves where $V_{DD} = 5$ V, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3$ V, all loads are referenced to 1.5 V.



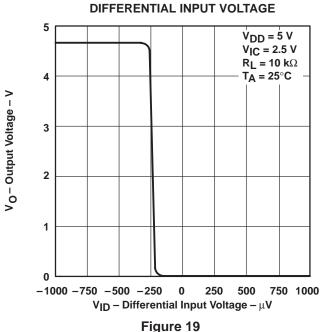
[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

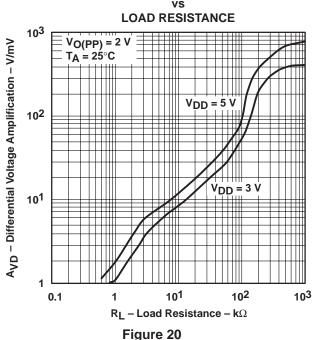
SHORT-CIRCUIT OUTPUT CURRENT†‡ FREE-AIR TEMPERATURE 14 $V_{DD} = 5 V$ V_{IC} = 2.5 V IOS - Short-Circuit Output Current - mA 12 $V_0 = 2.5 \text{ V}$ 10 $V_{ID} = -100 \text{ mV}$ 8 2 $V_{ID} = 100 \text{ mV}$ 0 -75 -50 -25 25 75 100 125 T_A - Free-Air Temperature - °C





OUTPUT VOLTAGE‡ DIFFERENTIAL VOLTAGE AMPLIFICATION[‡]





[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

[‡] For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.



TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN†

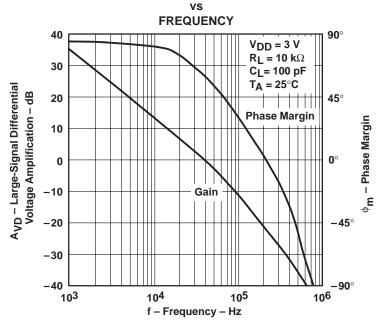


Figure 21

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN[†]

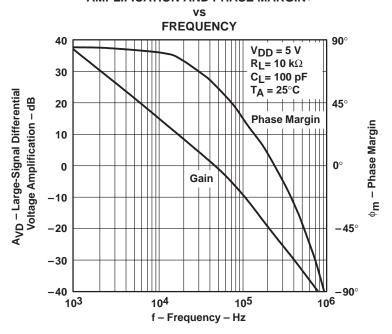


Figure 22

 \dagger For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.



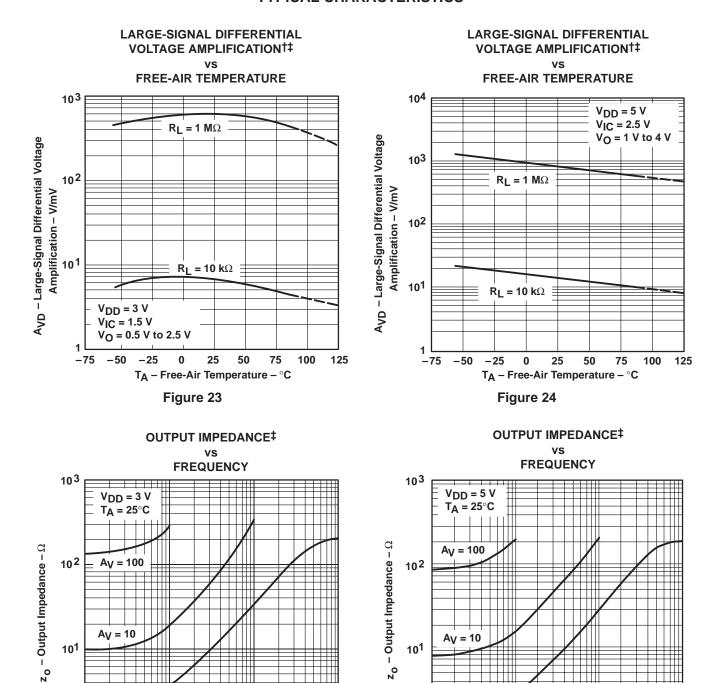


Figure 25 Figure 26 †Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

10³



 $A_V = 1$

101

102

f- Frequency - Hz

103

104

101

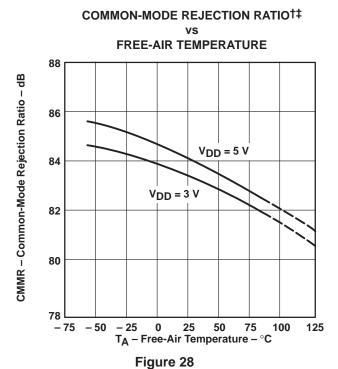
10²

f- Frequency - Hz

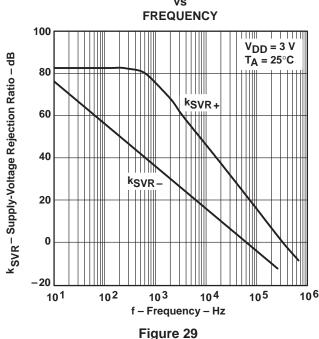
104

‡ For all curves where $V_{DD} = 5 \text{ V}$, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3 \text{ V}$, all loads are referenced to 1.5 V.

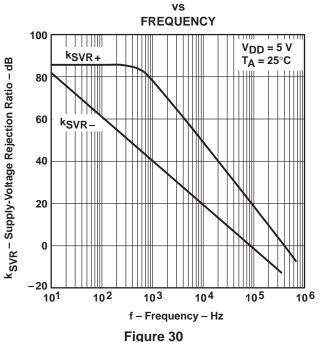
COMMON-MODE REJECTION RATIO† **FREQUENCY** 100 T_A = 25°C CMRR - Common-Mode Rejection Ratio - dB $V_{DD} = 5 V$ $V_0 = 2.5 \text{ V}$ 80 $V_{DD} = 3 V$ 60 V_O = 1.5 V 40 20 101 102 103 104 10⁵ f - Frequency - Hz Figure 27



SUPPLY-VOLTAGE REJECTION RATIO†



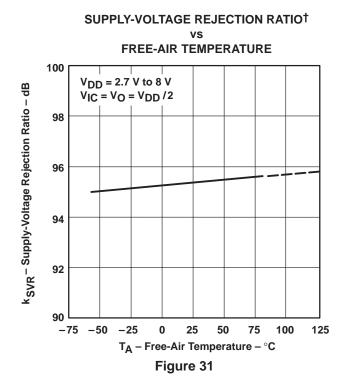


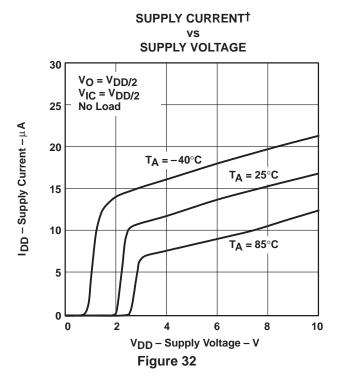


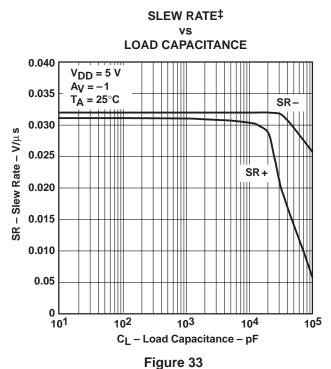
[†] For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

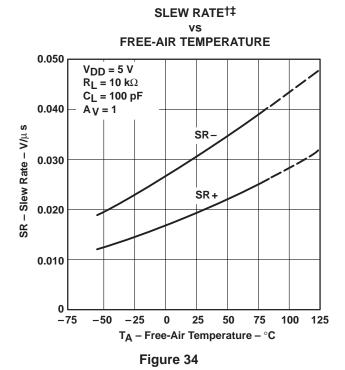
[‡] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.











[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

 $[\]ddagger$ For all curves where $V_{DD} = 5$ V, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3$ V, all loads are referenced to 1.5 V.



INVERTING LARGE-SIGNAL PULSE RESPONSE† 3 $V_{DD} = 3 V$ $R_L = 10 \text{ k}\Omega$ $C_{L}^{-} = 100 \text{ pF}$ 2.5 $A_{V}^{-} = -1$ $T_A = 25^{\circ}C$ Vo - Output Voltage - V 2 1.5 1 0.5 100 150 200 250 300 350 400 450 500 $t - Time - \mu s$ Figure 35

VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE[†]

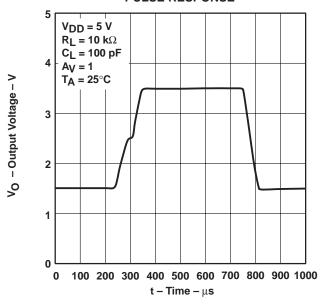
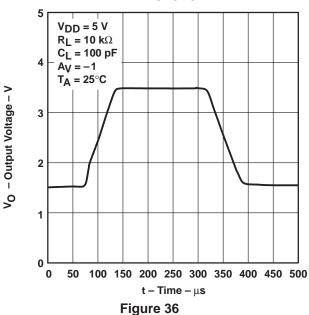
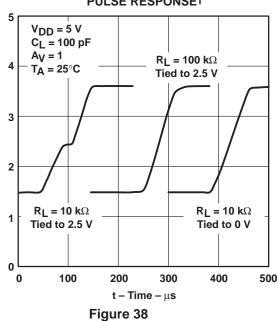


Figure 37

INVERTING LARGE-SIGNAL PULSE RESPONSE[†]



VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE[†]

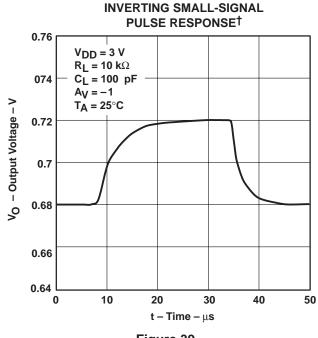


† For all curves where $V_{DD} = 5 \text{ V}$, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3 \text{ V}$, all loads are referenced to 1.5 V.



- Output Voltage - V

0





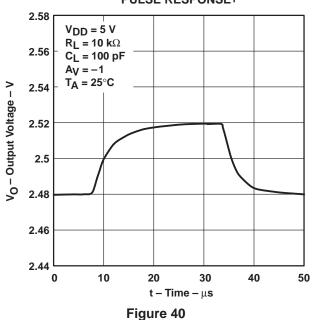
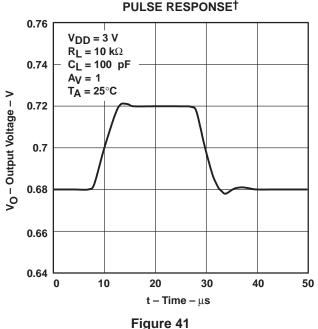


Figure 39

VOLTAGE-FOLLOWER SMALL-SIGNAL



VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE†

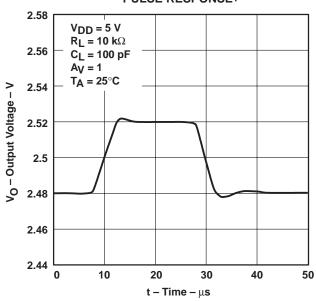


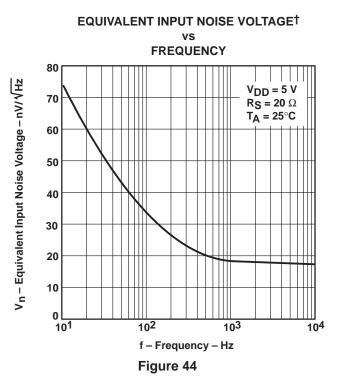
Figure 42

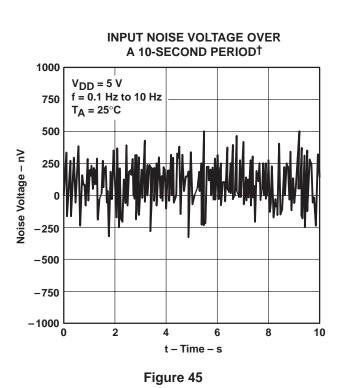
† For all curves where V_{DD} = 5 V, all loads are referenced to 2.5 V. For all curves where V_{DD} = 3 V, all loads are referenced to 1.5 V.

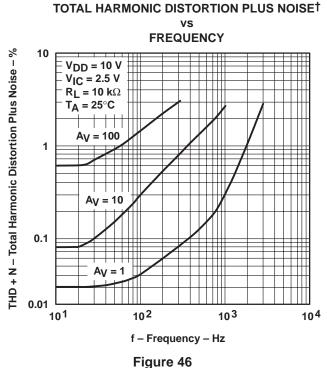


TYPICAL CHARACTERISTICS

EQUIVALENT INPUT NOISE VOLTAGE[†] **FREQUENCY** 80 $V_{n}-$ Equivalent Input Noise Voltage - nV/\sqrt{Hz} $V_{DD} = 3 V$ $R_S = 20 \Omega$ 70 $T_A = 25^{\circ}C$ 60 50 40 30 20 10 0 101 102 103 104 f - Frequency - Hz Figure 43



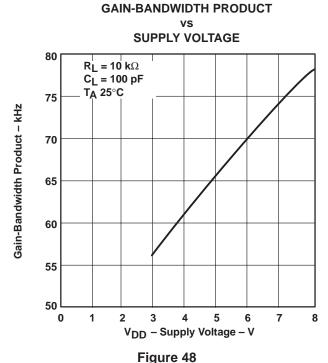




† For all curves where $V_{DD} = 5 \text{ V}$, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3 \text{ V}$, all loads are referenced to 1.5 V.



GAIN-BANDWIDTH PRODUCT†‡ FREE-AIR TEMPERATURE 80 $V_{DD} = 5 V$ f = 10 kHz $R_L = 10 \text{ k}\Omega$ 75 $C_{L} = 100 pF$ Gain-Bandwidth Product - kHz 70 65 60 55 50 25 -75-50-25 0 50 75 100 125 T_A – Free-Air Temperature – °C Figure 47



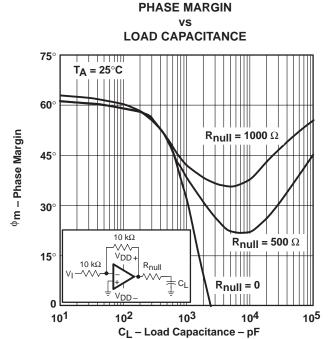
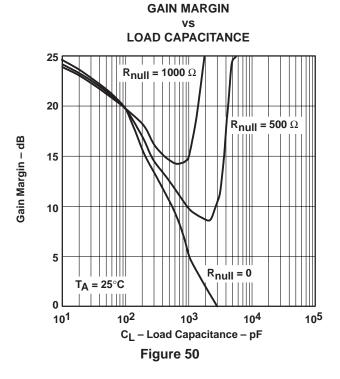


Figure 49



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

[‡] For all curves where $V_{DD} = 5 \text{ V}$, all loads are referenced to 2.5 V. For all curves where $V_{DD} = 3 \text{ V}$, all loads are referenced to 1.5 V.



UNITY-GAIN BANDWIDTH vs LOAD CAPACITANCE

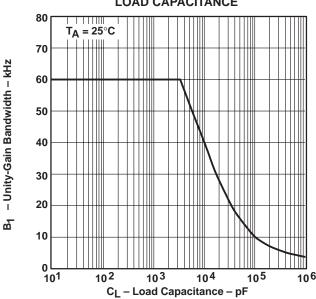


Figure 51

APPLICATION INFORMATION

driving large capacitive loads

The TLV2211 is designed to drive larger capacitive loads than most CMOS operational amplifiers. Figure 49 and Figure 50 illustrate its ability to drive loads up to 600 pF while maintaining good gain and phase margins $(R_{null} = 0)$.

A smaller series resistor (R_{null}) at the output of the device (see Figure 52) improves the gain and phase margins when driving large capacitive loads. Figure 49 and Figure 50 show the effects of adding series resistances of 500 Ω and 1000 Ω . The addition of this series resistor has two effects: the first is that it adds a zero to the transfer function and the second is that it reduces the frequency of the pole associated with the output load in the transfer function.

The zero introduced to the transfer function is equal to the series resistance times the load capacitance. To calculate the improvement in phase margin, equation (1) can be used.

$$\Delta \phi_{m1} = \tan^{-1} \left(2 \times \pi \times UGBW \times R_{null} \times C_{L} \right)$$
 (1)

where:

 $\Delta \varphi_{m1} = improvement in phase margin$

UGBW = unity-gain bandwidth frequency

R_{null} = output series resistance

 C_1 = load capacitance



APPLICATION INFORMATION

driving large capacitive loads (continued)

The unity-gain bandwidth (UGBW) frequency decreases as the capacitive load increases (see Figure 51). To use equation (1), UGBW must be approximated from Figure 51.

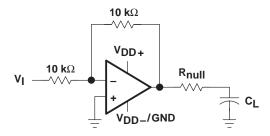


Figure 52. Series-Resistance Circuit

driving heavy dc loads

The TLV2211 is designed to provide better sinking and sourcing output currents than earlier CMOS rail-to-rail output devices. This device is specified to sink 500 μ A and source 250 μ A at V_{DD} = 3 V and V_{DD} = 5 V at a maximum quiescent I_{DD} of 25 μ A. This provides a greater than 90% power efficiency.

When driving heavy dc loads, such as $10 \text{ k}\Omega$, the positive edge under slewing conditions can experience some distortion. This condition can be seen in Figure 37. This condition is affected by three factors.

- Where the load is referenced. When the load is referenced to either rail, this condition does not occur. The distortion occurs only when the output signal swings through the point where the load is referenced. Figure 38 illustrates two $10-k\Omega$ load conditions. The first load condition shows the distortion seen for a $10-k\Omega$ load tied to 2.5 V. The third load condition shows no distortion for a $10-k\Omega$ load tied to 0 V.
- Load resistance. As the load resistance increases, the distortion seen on the output decreases. Figure 38 illustrates the difference seen on the output for a $10-k\Omega$ load and a $100-k\Omega$ load with both tied to 2.5 V.
- Input signal edge rate. Faster input edge rates for a step input result in more distortion than with slower input edge rates.



APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim $Parts^{TM}$, the model generation software used with Microsim $PSpice^{TM}$. The Boyle macromodel (see Note 6) and subcircuit in Figure 53 are generated using the TLV2211 typical electrical and operating characteristics at $T_A = 25$ °C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification

- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 6: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

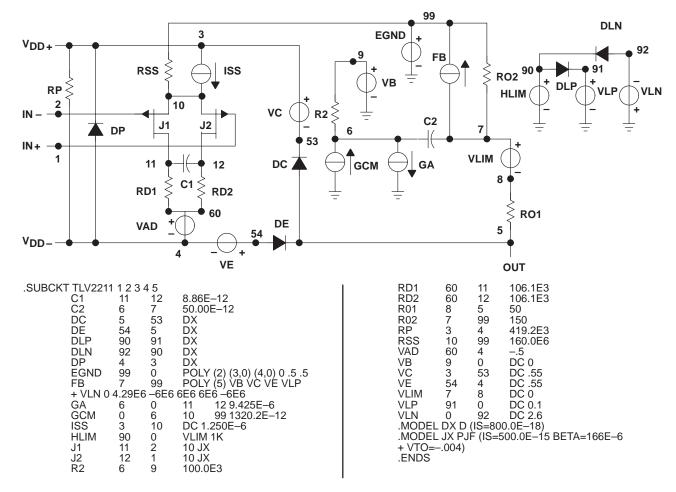


Figure 53. Boyle Macromodel and Subcircuit

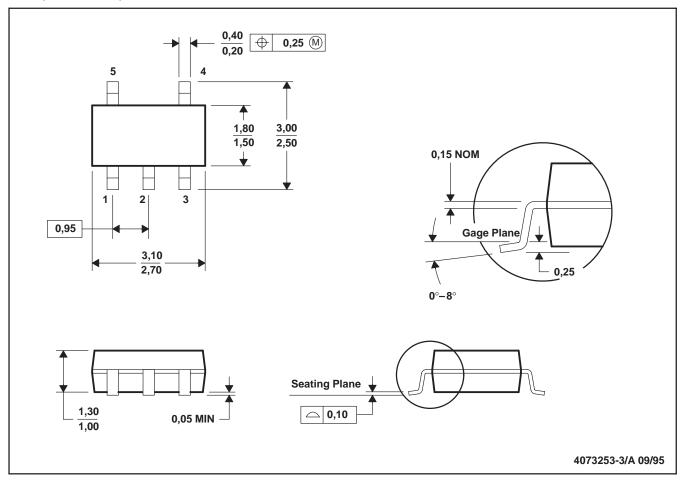
PSpice and Parts are trademark of MicroSim Corporation.



MECHANICAL INFORMATION

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions include mold flash or protrusion.

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated